TOAHIBA Bi-CMOS Integrated Circuit Silicon Monolithic

TB62710P, TB62710F, TB62710FN

8-Bit Constant-Current LED Driver for Cathode Common LED

The TB62710P, TB62710F and TB62710FN are specifically designed for use as LED and LED display (cathode-common) Constant-current drivers.

The constant-current output circuits can be set up using an external resistor (IOUT = -90 mA max).

These ICs are monolithic integrated circuits have been designed using the Bi-CMOS process.

The devices consist of an 8-bit shift register, a latch, an AND gate and constant-current drivers.

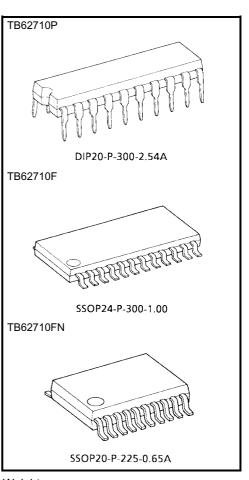
FEATURES

- Constant-current output: A single resistor can be used to set any output current in the range -5~-90 mA.
- Maximum clock frequency: $f_{CLK} = 15 \text{ MHz}$ (operating while connected in cascade, $T_{opr} = 25^{\circ}C$)
- 5-V CMOS compatible input
- Packages:

P-type: DIP20-P-300-2.54A F-type: SSOP24-P-300-1.00 FN-type: SSOP20-P-225-0.65A

Constant-output-current accuracy:

Output – GND	Current a	Output Current	
Voltage	between bits	between ICs	(max)
≧ 2.0 V (min)	+6%	±15%	–5~–90 mA
≧ 1.5 V (min)	±0 %	1576	–5~–40 mA



Weight:

DIP20-P-300-2.54A: 2.25 g (Typ.) SSOP24-P-300-1.00: 0.33 g (Typ.) SSOP20-P-225-0.65A: 0.10 g (Typ.)

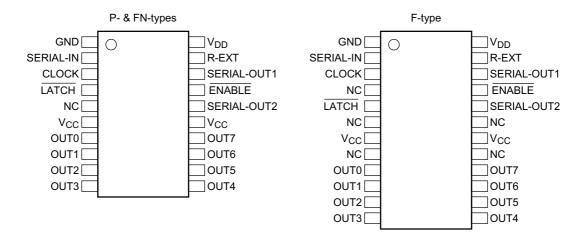
Company Headquarters 3 Northway Lane North Latham, New York 12110 Toll Free: 800.984.5337 Fax: 518.785.4725



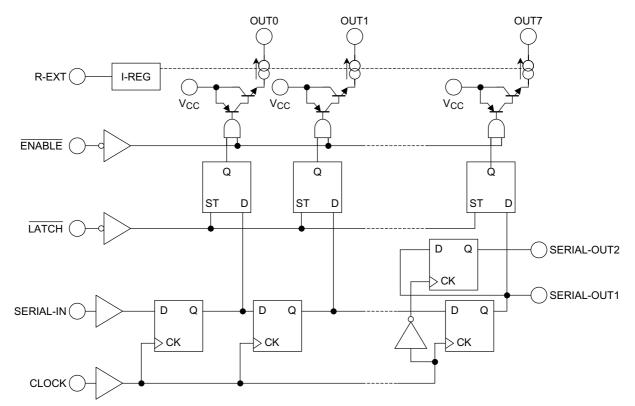
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Pin Assignment (top view)



Block Diagram



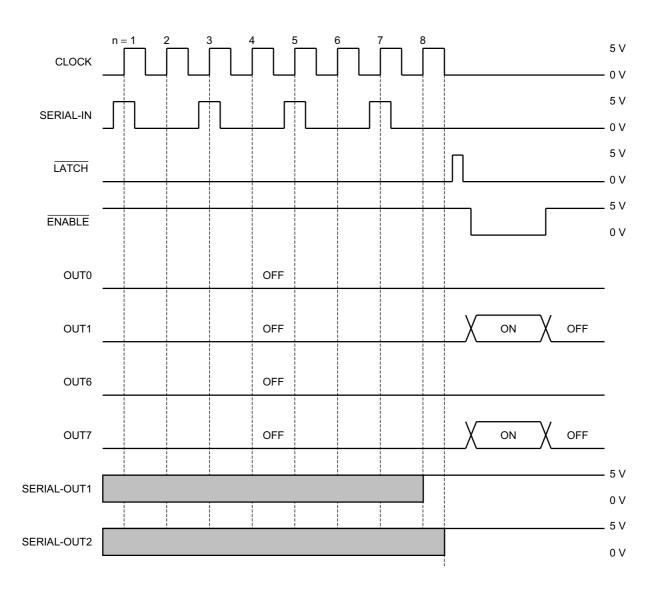
Truth Table

CLOCK	LATCH	ENABLE	SERIAL-IN	OUT0··· OUT5 ··· OUT7	SERIAL-OUT
	Н	L	Dn	Dn … Dn – 5 … Dn – 7	Dn – 7
	L	L	Dn + 1	No Change	Dn – 6
	Н	L	Dn + 2	$Dn + 2 \cdots Dn - 3 \cdots Dn - 5$	Dn – 5
	Х	L	Dn + 3	$Dn + 2 \cdots Dn - 3 \cdots Dn - 5$	Dn – 5
	х	н	Dn + 3	OFF	Dn – 5

Note 1: OUT0~OUT7 = ON when Dn = "H"; OUT0~OUT7 = OFF when Dn = "L".

In order to ensure that the level of the power supply voltate is correct, an external resistor must be connected between R-EXT and GND.

Timing Diagram



Note 2: The latches circuit holds data by pulling the LATCH terminal Low. And, when LATCH terminal is a "H" level, latch circuit doesn't hold data, and it passes from the input to the output.

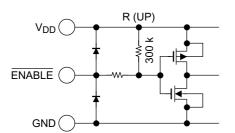
When $\overline{\mathsf{ENABLE}}$ terminal is a "L" level, output terminal OUT0~ OUT7 respond to the data, and on & off does. And, when $\overline{\mathsf{ENABLE}}$ terminal is a "H" level, it offs with the output terminal regardless of the data.

Terminal Description

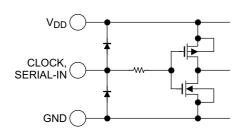
Pin No.		Pin Name	Function				
P/FN-Type	F-Type	Pin Name					
1	1	GND	GND terminal for control logic				
2	2	SERIAL-IN	Input terminal for serial data for data shift register				
3	3	CLOCK	Input terminal for clock for data shift on rising edge				
4	5	LATCH	Input terminal for data strobe When the LATCH input is driven High, data is latched. When it is pulled Low, data is hold.				
6, 15	7, 18	V _{CC}	0 V~17 V supply voltage terminal for LED				
7~14	9~16	OUT0~OUT7	Output terminals				
17	21	ENABLE	Input terminal for output enable. All outputs (OUT0~OUT7) are turned off, when the ENABLE terminal is driven High. And are turned on, when the terminal is driven Low.				
16	20	SERIAL-OUT2	Output terminal for serial data input on SERIAL-IN terminal				
18	22	SERIAL-OUT1	Output terminal for serial data input on SERIAL-IN terminal				
19	23	R-EXT	Input terminal used to connect an external resistor. This regulated the output current.				
20	24	V _{DD}	5-V supply voltage terminal				
5	4, 6, 8, 17, 19	NC	Not connected				

Equivalent Circuits For Inputs and Outputs

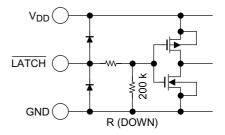
ENABLE terminal



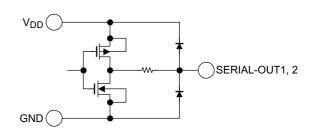
CLOCK, SERIAL-IN terminal



LATCH terminal



SERIAL-OUT1 and SERIAL-OUT2 terminals



Maximum Ratings (T_{opr} = 25°C)

Characteristic		Symbol	Rating	Unit
Supply voltage		V _{DD}	0~7.0	V
Supply voltage f	or LED	V _{LED}	0~17.0	V
Input voltage		V _{IN}	$-0.4 \sim V_{DD} + 0.4$	V
Output current		I _{OUT}	-90	mA
Output voltage		V _{OUT}	-0.4~17	V
Clock frequency	,	f _{CLK}	15	MHz
V _{CC} terminal cu	rrent	IV _{CC}	1440	mA
	P-type (when not mounted)	P _{d1}	1.47	
Power Dissipation	F-type (when not mounted)	P _{d2}	0.59	
(Note 3)	F-type (on PCB)		0.83	W
	FN-type (when not mounted)	P _{d3}	0.71	
	FN-type (on PCB)		0.96	
	P-type (when not mounted)	R _{th (j-a) 1}	85	
Thermal Resistance	F-type (when not mounted)	R _{th (i-a) 2}	210	
(Note 3)	F-type (on PCB)	с, , , , , , , , , , , , , , , , , , ,	150	°C/W
(NOLE 3)	FN-type (when not mounted)	R _{th (j-a) 3}	175	
	FN-type (on PCB)	, , , , , , , , , , , , , , , , , , ,	130	
Operating Temperature		T _{opr}	-40~85	°C
Storage Temper	ature	T _{stg}	-55~150	°C

Note 3: P-Type: Powes dissipation is derated by 12.5 mW/°C if device is mounted on PCB and ambient temperature is above 25°C.

F-Type: Powes dissipation is derated by 6.7 mW/°C if device is mounted on PCB and ambient temperature is above 25°C.

With device mounted on PCB of 60% Cu and of dimensions 50 mm \times 50 mm \times 1.6 mm

FN-Type: Powes dissipation is derated by 7.7 mW/°C if device is mounted on PCB and ambient temperature is above 25°C.

With device mounted on PCB of 40% Cu and of dimensions 50 mm \times 50 mm \times 1.6 mm

Recommended Operating Conditions ($T_{opr} = -40^{\circ}C \sim 85^{\circ}C$ unless otherwise specified)

Charac	cteristic	Symbol	Conditions		Min	Тур.	Max	Unit	
Supply voltage		V _{DD}		—		5.0	5.5	V	
Supply voltage for LED		V _{CC1}	$V_{CC} - V_{OUT} \ge 2.0 \text{ V},$ $I_{OUT} \le -90 \text{ mA}$ $V_{CC} - V_{OUT} \ge 1.5 \text{ V},$ $I_{OUT} \le -40 \text{ mA}$		4		17	v	
		V _{CC2}			3.5		17		
Output voltage		V _{OUT}	V _{CC} common		0	_	-17	V	
		IOUT	DC1 circuit		-5	_	-78		
Output current	Output current		SERIAL-OUT1,	2	_		-1.0	mA	
		l _{OL}	SERIAL-OUT1,		_	1.0			
		VIH	- V _{DD} = 4.5~5.5 V		0.7 V _{DD}		V _{DD} + 0.3	V	
input voitage	Input voltage		- v _{DD} = 4.5~5.5 v	-0.3		0.3 V _{DD}			
LATCH pulse wid	th	t _{wLAT}	V _{DD} = 4.5~5.5 V	,	100			ns	
CLOCK pulse width	ı	t _{wCLK}	V _{DD} = 4.5~5.5 V	,	50			ns	
ENABLE pulse wi	dth	t _{wENA}	V _{DD} = 4.5~5.5 V	,	1000	_		ns	
Set-up time for DA	ГА	t _{setup}	V _{DD} = 4.5~5.5 V		100			ns	
Hold time for DATA	Hold time for DATA thold		V _{DD} = 4.5~5.5 V		100			ns	
Clock frequency	Clock frequency t _{CLK}		$V_{DD} = 4.5 \sim 5.5 V$, Cascade operation		—	_	10.0	ns	
Power Dissipation	P-type	P _{d1}	$T_{opr} = 85^{\circ}C$ When not mount On PCB	When not mount	When not mounted	—	_	0.76	
	F-type	P _{d2}		= 85°C	—	_	0.43	W	
	FN-type	P _{d3}				_	0.50		

Electrical Characteristics ($T_{opr} = 25^{\circ}C$, $V_{DD} = 5$ V, $V_{CC} = 17$ V unless otherwise specified)

Charact	teristic	Symbol	Test circuit	Conditions		Min	Тур.	Max	Unit
Output leakage cu	urrent	I _{LEAK}	_	V _{CC} = 17.0 V		_		-10	μA
Output voltage	SERIAL-OUT	V _{OH}	_	I _{OH} = -1.0 mA		_		0.4	V
Output voltage	1, 2	V _{OL}		I _{OL} = 1.0 mA		4.6			v
		I _{OUT1}	_	$V_{CC} = 4 \text{ V},$ $V_{OUT} = V_{CC} - 2.0 \text{ V}$	R _{EXT} = 360 Ω	-62.1	-73.0	-83.9	
Output current (including current	skewing)	I _{OUT2}	_	$\begin{array}{l} V_{CC} = 4 \ V, \\ V_{OUT} = V_{CC} - 2.0 \ V \end{array}$	$R_{EXT} = 620 \Omega$	-34.0	-40.0	-46.0	mA
		I _{OUT3}		$V_{CC} = 3.5 V,$ $V_{OUT} = V_{CC} - 1.5 V$	$R_{EXT} = 620 \ \Omega$	-32.3	-38.0	-43.7	
	Current skew	ΔI_{OUT}	_	Same as I _{OUT1} , I _{OUT2} and I _{OUT3}			±1.5	±6.0	%
Supply voltage reg	Supply voltage regulation		_	Ta = -40~85°C	$R_{EXT} = 360 \ \Omega$	_	1.5	5.0	%/V
Pull-up resistor	Pull-up resistor		—	—	150	300	600	kΩ	
Pull-down resistor		R _{in (Down)}	—	—	100	200	400	kΩ	
		I _{DD (OFF)}	—	All outputs = OFF	$R_{EXT} = OPEN$	_	0.6	1.2	
	V _{DD}	I _{DD} (ON) 1	_	DATA = ALL "H", All outputs = ON (no load)	R _{EXT} = 360 Ω	_	7.5	10.0	
Supply current		I _{DD} (ON) 2	_	DATA = ALL "H", All outputs = ON (no load)	R _{EXT} = 620 Ω	_	4.0	7.0	mA
		ICC (OFF)	_	DATA = ALL "L", All outputs = OFF (no load)	R _{EXT} = 620 Ω	_	0.5	1.0	
	Vcc	ICC (ON)		DATA = ALL "H", All outputs = ON (no load)	R _{EXT} = 360 Ω	_	42.0	52.0	

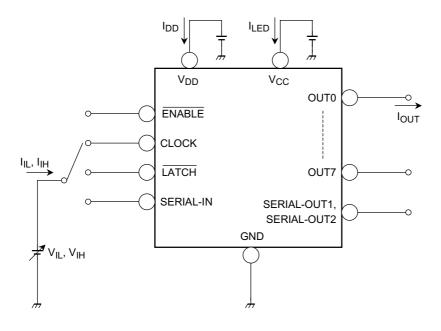
Switching Characteristics ($T_{opr} = 25^{\circ}C$ unless otherwise specifed)

Char	acteristic	Symbol	Test circuit	Conditions	Min	Тур.	Max	Unit
	CLK-OUTn		—					
Propagation	LATCH -OUTn	4	_		—	200	450	20
delay time ("L" to "H")	ENABLE -OUTn	t _{pLH}	_					ns
	CLK-SOUTn		—	V _{DD} = 5.0 V, V _{CC} = 17.0 V	_	20	70	
	CLK-OUTn		—	$V_{OUT} = V_{CC} - 2.0 V$				
Propagation delay time	LATCH -OUTn	+	—	$V_{IH} = V_{DD}, V_{IL} = GND$	—	60	180	ns
("H" to "L")	ENABLE -OUTn	t _{pHL}	—	R _{EXT} = 620 Ω				115
	CLK-SOUTn		—	C _L = 10.5 pF	_	20	70	
Pulse width	CLK	t _{wCLK}	—	t _{or} : 10~90%	_	20	30	
Fuise width	LATCH	t _{wLAT}	—	t _{of} : 90~10%	_	10	25	ns
Set-up time			_	t _{pLH} : 50~10%				
LATCH /SIN/ CLOCK	$DATA = ``L" \to ``H"$	t _{setup}	_	t _{pHL} : 50~90%	_	25	50	ns
Hold time			_					
LATCH /SIN/ CLOCK	$DATA = ``H" \to ``L"$	t _{hold}	_	Set the switching	_	0	30	ns
Slow clock	Rise time (Note 4)	tr	_	characteristics according to the result of measuring the voltage waveform.		_	10	μs
	Fall time (Note 4)	t _f	_		_	_	10	μs
Output rise time		t _{or}	_		25	55	110	ns
Output fall time		t _{of}	—		250	450	600	ns

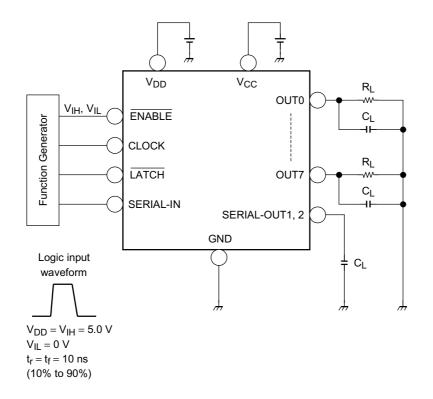
Note 4: If the device is connected in a cascade and t_r/t_f for the waveform is large, it may not be possible to achieve the timing required for data transfer. Please consider the timings carefully.

Test Circuit

DC Characteristic

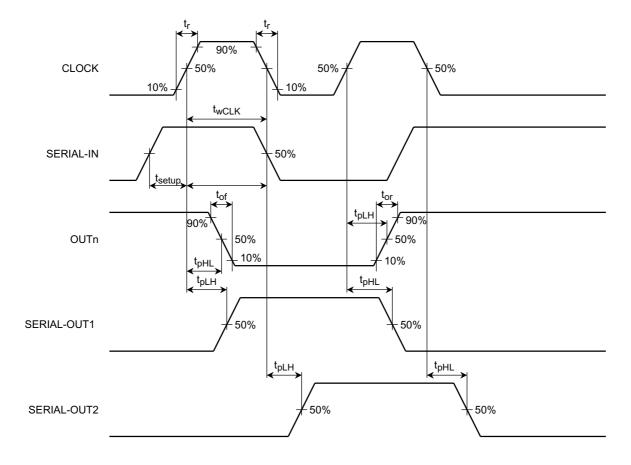


AC Characteristic

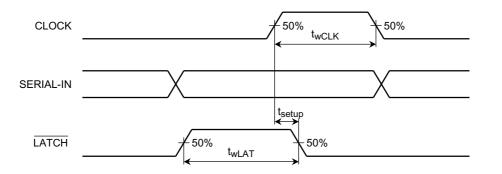


Timing Waveforms

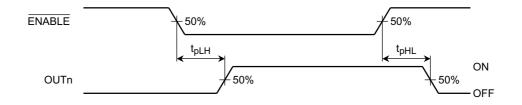
1. CLOCK, SERIAL OUTn



2. CLOCK, LATCH

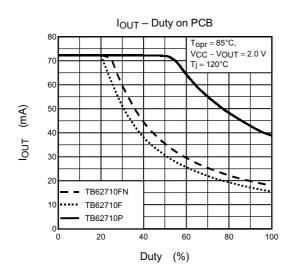


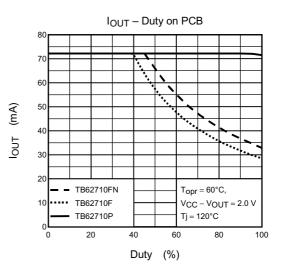
3. ENABLE – OUTn

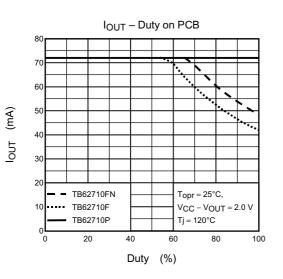


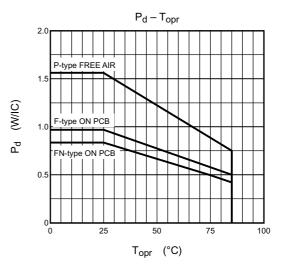
<u>TOSHIBA</u>

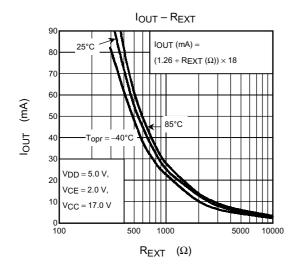
Reference Data (duty curves + package power dissipation)











The bottom figure shows an application circuit. For best results, this IC should be operated with VO = 2.0 V.

VO (V) = VCC - VOUT= VCC - Vf (LED) - VCE1

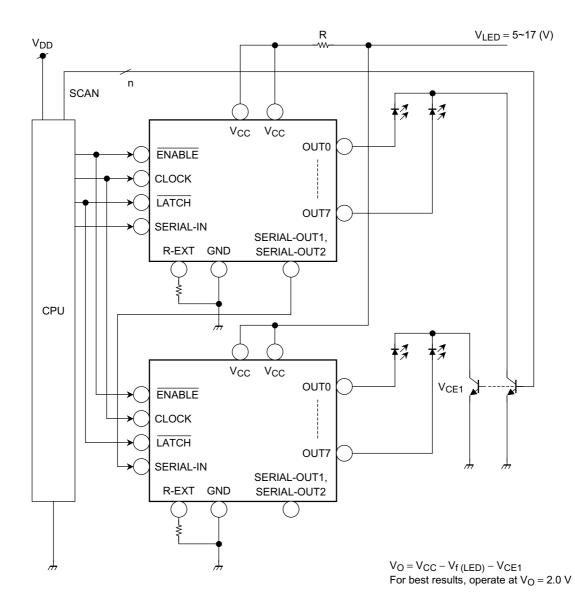
When VCC is high and the Vf of the LED is low. VO is also high , the increase in power dissipation may in turn adversely affect the IC's output current. In this case, reduce the voltage by connecting an external resistor. In this way the IC's output current can be stabilized.

 $R = \frac{V_{CC} - V_{f} - V_{O} (min)}{I_{OUT} (max) \times BIT number (max)}$

It is looked for.

it is also possible that the IC will operate in an unstable manner due to the inductance of the wiring. To counter this, it is recommended that the IC be situated as close as possible on the PCB to the LED module, and as far as possible from other ICs. Otherwise, there is the risk that the IC will malfunction.

Application



Notes

• Operation may become unstable due to the electromagnetic interference caused by the wiring and other phenomena.

To counter this, it is recommended that the IC be situated as close as possible to the LED module. If overvoltage is caused by inductance between the LED and the output terminals, both the LED and the terminals may suffer damage as a result.

• There is only one GND terminal on this device when the inductance in the GND line and the resistor are large, the device may malfunction due to the GND noise when output switchings by the circuit board pattern and wiring.

To achieve stable operation, it is necessary to connect a resistor between the REXT terminal and the GND line. Fluctuation in the output waveform is likely to occur when the GND line is unstable or when a capacitor (of more than 50 pF) is used.

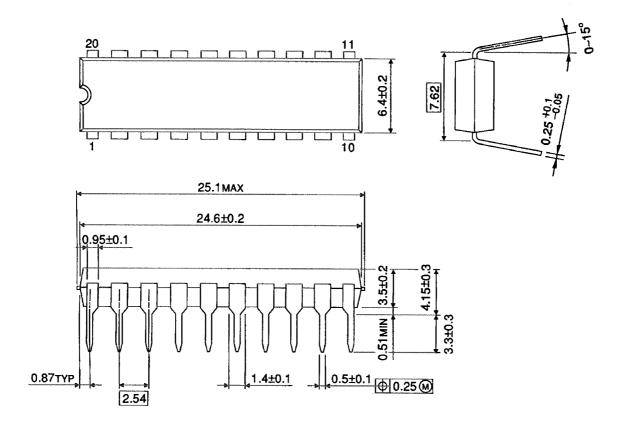
Therefore, take care when designing the circuit board pattern layout and the wiring from the controller.

- This application circuit is a reference example and is not guaranteed to work in all conditions. Be sure to check the operation of your circuits.
- This device does not include protection circuits for overvoltage, overcurrent or overtemperature. If protection is necessary, it must be incorporated into the control circuitry.
- The device is likely to be destroyed if a short-circuit occurs between either of the power supply pins and any of the output terminals when designing circuits, pay special attention to the positions of the output terminals and the power supply terminals (V_{DD} and V_{LED}), and to the design of the GND line.

Package Dimensions

DIP20-P-300-2.54A

Unit : mm

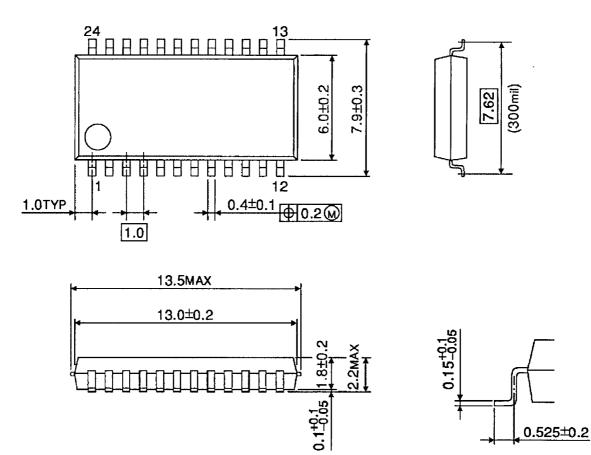


質量: 2.25 g (標準)

Package Dimensions

SSOP24-P-300-1.00

Unit : mm

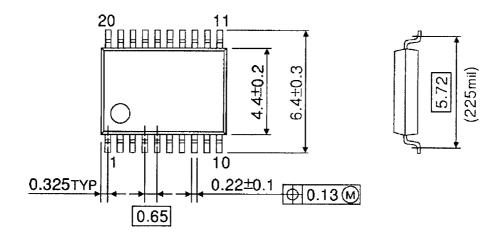


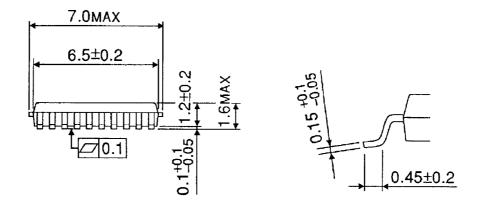
質量: 0.33 g (標準)

Package Dimensions

SSOP20-P-225-0.65A

Unit : mm





質量: .0.10 g (標準)

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